# **BASIC BLADE & BEAM**

(0.635 mm) .025" PITCH • BTS/BSS SERIES





**BSS** 

**BSS** Mates:

## **SPECIFICATIONS**

Insulator Material: Liquid Crystal Polymer Terminal Material: Phosphor Bronze
Contact Material: Phosphor Bronze **Plating:** Au or Sn over 50 μ" (1.27 μm) Ni **Current Rating:** 1.8 A per pin (2 pins powered) **Operating Temp Range:** -55 °C to +125 °C

### **PROCESSING**

# Lead-Free Solderable:

SMT Lead Coplanarity: (0.10 mm) .004" max Board Stacking:

For applications requiring more than two connectors per board or 100 positions or higher, contact ipg@samtec.com

#### **ALSO AVAILABLE** MOQ Required

30 μ" (0.76 μm) Gold Other platings Other positions

# **MATED HEIGHT**

LEAD STYLE MATED HEIGHT\*

(5.00 mm) .197"

**BSS** 

\*Processing conditions will affect mated height.



Some lengths, styles and options are non-standard, non-returnable.



-025, -050, -075, -100

**PLATING OPTION** 

Gold Flash

on contact, Matte Tin on tail

= 10 μ" (0.25 μm) Gold on contact, Matte Tin on tail

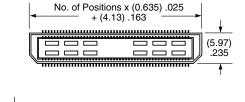
# -K = (7.00 mm).275" DIA Polyimide Film Pick & Place Pad

**OTHER** 

**OPTION** 

= Tape & Reel (–100 positions max.)

-FR = Full Reel Tape & Reel (must order max. quantity per reel; contact Samtec for quantity breaks) (–100 positions max.)









-025, -050, -075, -100

OPTION







Gold Flash on contact, Matte Tin on tail

**-L** = 10 μ" (0.25 μm) Gold on contact, Matte Tin on tail



-FR = Full Reel Tape & Reel (must order maximum quantity per reel; contact Samtec for quantity breaks) (-100 positions maximum)

